

Abstract Submitted  
for the MAR05 Meeting of  
The American Physical Society

**Correlation Between Interfacial Moisture Content and Adhesive Fracture Energy** EMMETT O'BRIEN<sup>1</sup>, BRYAN VOGT<sup>2</sup>, CHRISTOPHER WHITE<sup>3</sup>, NIST — The effect of surface chemistry and moisture on adhesion was investigated using neutron reflectivity and the shaft-loaded blister test. Four different surface treatments were examined: bare Al<sub>2</sub>O<sub>3</sub>, t-butylphosphonic acid, phenyl phosphonic acid, and n-octyltrichlorosilane. Measurements were taken in the dry condition and after samples were equilibrated in a 100% relative humidity. Previous neutron reflectivity work by Vogt (submitted to *Macromolecules*) on spincoated films of poly(4-tert-butoxycarbonyl-oxystyrene) has shown that the phenyl and octyl surface treatments reduced the amount of water at the interface, relative to the bare aluminum. The t-butyl treatment did not reduce the interfacial moisture content. These results were correlated to adhesive fracture energy measurement of spin coated PMMA films. The adhesion measurements match the expected trend. The phenyl surface had the largest adhesion strength and a low interfacial moisture content. The t-butyl and bare Al<sub>2</sub>O<sub>3</sub> surface had similar moisture contents and adhesion energy. The octyl treated surface had the worst adhesion but the lowest interfacial moisture content.

<sup>1</sup>Buildings and Fire Research Laboratory

<sup>2</sup>Polymers Division

<sup>3</sup>Buildings and Fire Research Laboratory

Christopher White  
NIST

Date submitted: 09 Nov 2004

Electronic form version 1.4